



### **6A STANDARD RECOVERY BRIDGE RECTIFIER**

# **Product Summary**

V <sub>RRM</sub> (V)	/)		I <sub>R</sub> Max (μA)	
1000	6	1.0	5	

### **Mechanical Data**

- Case: TTL
- Case Material: "Green" Molding Compound, UL Flammability Classification 94V-0, (No Br. Sb. Cl.)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- · Polarity Indicator: As Marked on The Body
- Weight: 0.41 grams (Approximate)



### **Features**

- Glass Passivated Die Construction
- Ideal for Printed Circuit Board
- Reliable Low Cost Construction Utilizing Molded Plastic Technique
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/



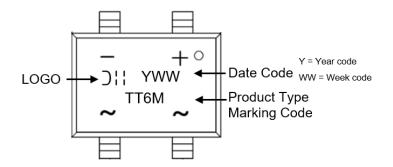
## Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
TT6M	Commercial	TTL	1500/Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**





# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic			Value	Unit
Maximum Repetitive Peak Reverse Voltage			1000	V
Maximum DC Blocking Voltage			1000	V
Average Rectified Output Current	@T <sub>A</sub> = +25°C (Note 5)	I <sub>F(AV)</sub>	6.0	Α
Peak Forward Surge Current 8.3ms Single Half Sine-Wave	@T <sub>A</sub> = +25°C @T <sub>A</sub> = +125°C	IFSM	150 120	А
Peak Forward Surge Current 1.0ms Single Half Sine-Wave	@T <sub>A</sub> = +25°C @T <sub>A</sub> = +125°C	IFSM	300 240	Α
I <sup>2</sup> t Rating for Fusing (t = 8.3ms)		I <sup>2</sup> t	93.3	A <sup>2</sup> s
Operating and Storage Temperature Range	_	TJ,TSTG	-55 to +150	°C

# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Test Condition		Symbol	Тур.	Max	Unit
Forward Voltage	I <sub>F</sub> = 3A	T <sub>A</sub> = +25°C T <sub>A</sub> = +125°C	VF	0.93 0.82	1.0	V
Leakage Current	V <sub>R</sub> = 1000V	T <sub>A</sub> = +25°C T <sub>A</sub> = +125°C	IR	0.07 20	5 500	μΑ
Typical Junction Capacitance (Note 6)			CJ	4	6	pF

### **Thermal Characteristics**

Characteristic	Symbol	Тур.	Unit
Typical Thermal Resistance (Without Heatsink)	Rejc Rejl Reja	8 9 45	°C/W
Typical Thermal Resistance (Note 7)	Rejc Rejl Reja	2 6 12	°C/W

Notes:

- 5. Perform static test after the temperature of oven is steady 20 minutes.
  6. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
  7. Thermal resistance junction to case, lead and ambient in accordance with JESD-51.

  Unit mounted on 15mmx12mmx1.6mm AL pad attached on 100mmx75mmx27mm AL fin heatsink.



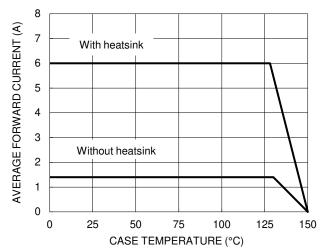


Figure 1. Forward Current Derating Curve

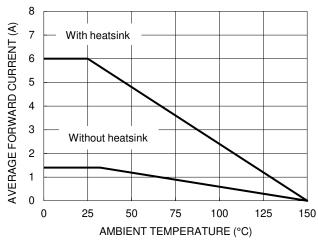


Figure 2. Forward Current Derating Curve

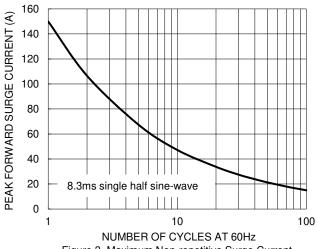
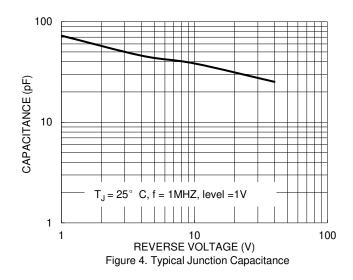
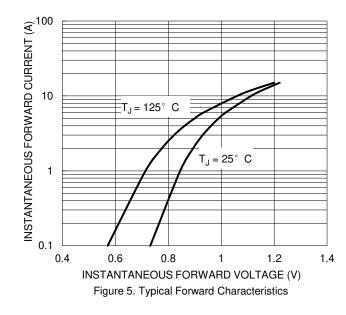
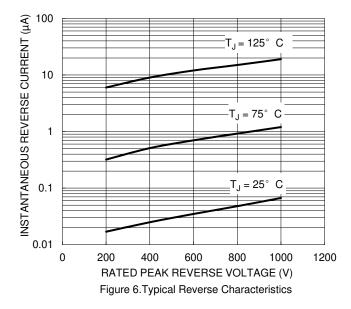


Figure 3. Maximum Non-repetitive Surge Current





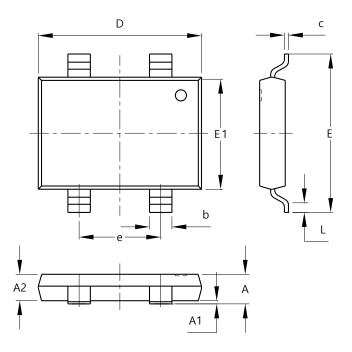




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

TTL

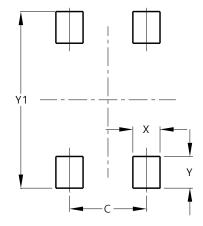


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Dim	Min	Max	TYP		
Α	1.45	1.80	1.65		
<b>A</b> 1	0.00	0.15	0.10		
A2	1.45	1.65	1.55		
b	1.30	1.50	1.40		
С	0.15	0.35	0.25		
D	10.05	10.35	10.20		
Е	9.75	10.05	9.90		
E1	6.85	7.15	7.00		
е	4.90	5.10	5.00		
L	0.45	0.95	0.70		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

TTL



Dimensions	Value		
	(in mm)		
С	5.00		
X	1.80		
Υ	2.10		
Y1	11.70		



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